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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**



Applicant: Wen-Ching Chen : Group  
Serial No: 10/662,433 : Art Unit # 2878  
Filed: 16 September 2003 : Examiner:  
Title: CHIP SCALE PACKAGE : D.J. Williams  
STRUCTURE FOR AN IMAGE

**RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT**

Honorable Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Responsive to the Notice of Non-Compliant Amendment dated 19 April  
2006 please amend the above-referenced Patent Application as follows:

**Amendments to the Claims** are reflected in the Corrected Listing of  
Claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 6 of this paper